

TTM Technologies, Inc. Asia Pacific's Silicon Platforms division in Shanghai receives best supplier award from SEMCO (Samsung Electro Mec Hanics Co., LTD.) for outstanding technical support.

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for immediate release

HONG KONG - April 3, 2012 - TTM Technologies, Inc. (Nasdaq: TTMI) announced that its Silicon Platforms facility in Shanghai ("SMST - SP") was presented with the 2011 Best Supplier Award for Best Product Innovation by SEMCO (Samsung Electro Mechanics Co., Ltd.) in recognition of its contribution and outstanding technical support for printed circuit boards. Eight other suppliers were also recognized by SEMCO for supplier excellence at an event in Suwon, Korea on Mar 30, 2012.

SMST - SP, a member of TTM Technologies, Inc. under the Asia Pacific Business Unit was established in 2002 to focus on the advanced technology IC substrate market including CSP, BOC, SIP, RF and memory modules. SMST- SP is located in Shanghai with about 900 employees.

TTM Technologies, Inc. is a major global printed circuit board manufacturer, focusing on quick-turn and technologically advanced PCBs and the backplane and sub-system assembly business. TTM stands for time-to-market, representing how the company's time-critical, one-stop manufacturing services enable customers to shorten the time required to develop new products and bring them to market. Additional information can be found at www.ttmtech.com/.

Company

TTM Technologies
(ticker: TTMI, exchange: NASDAQ)

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